

Material Set Change:

| Package Material Set | | Carsem | ASE Chungli |
|----------------------|---------------|---------------------|------------------|
| SOIC_N | Die Attach | Ablestik 84-1LMISR4 | Hitachi EN4900GC |
| | Mold Compound | Sumitomo 6600H | Sumitomo G700LY |
| | Wire | 1.3 mil Gold Wire | 1.3mil Gold Wire |